

**We are looking for you to join our international team of
successful Embedded Systems Engineers in our
Chipglobe Greece MIKE Center for 3 months**



Internship – Embedded Systems Design (f/m/d)

Chipglobe is focusing on Embedded Systems Design, RTL Design, and Verification Consulting with both Insourcing (at Customer premises) and Outsourcing (Chipglobe Design Center) working models. Our teams work in a global setup with ASIC design, verification, and software teams in major semiconductor companies, focusing on markets in automotive, telecommunications, security, and networking. Chipglobe headquarters are located in Munich, Germany with a Chipglobe Entity in Singapore and Chipglobe Design Centers in Belgrade, Serbia, Ho Chi Minh City in Vietnam, Thessaloniki in Greece, and Sofia in Bulgaria. We are more than 120 experts with an experienced management team. Based on the huge experience of our staff we manage and execute projects in a well-communicated, success-proven, and sustainable way. We love what we do, and we do what we love.

We are offering you a practical and latest Industry Trend Knowledge build-up

- ✓ Paid Internship is offered to fresh graduates or final year students of Electronics in a stable, German Chip Design/Verification Company for Semiconductors, aligned in its business ethics and conduct with major tier 1 companies.
- ✓ Excellent working environment, encouraging both technical and personal involvement
- ✓ Work on a commercial IoT project. This will give you a kick-start in your expertise.
- ✓ Stable and organized German working environment.
- ✓ The intern will have adequate support from senior engineers of Chipglobe, which will guide the Intern during the internship. Good results and development of new skills ensured.
- ✓ The internship will last 3 months, and the job could be offered to a successful candidate.
- ✓ The internship will be held in our office in Thessaloniki.
- ✓ Come and work for us and have a great kick-start of a Successful Career in Semiconductors!

Job requirements – Technical Skills

- ✓ Basic knowledge of embedded hardware and software design.
- ✓ General programming skills.

Job requirements – Soft Skills

- ✓ **Communication**
 - Able to abstract technical details
 - Good communication skills, enjoys working in an international team with some communication to Munich headquarters and EDA vendors
 - Good level of spoken and written English – must be able to understand and create technical documentation
- ✓ **Team player**
 - Committed to the team and task
 - Helping team members, sharing knowledge
- ✓ **Self-driven and highly motivated**
 - Self-motivated, Embracing the task
 - Highlight potential issues, Organized working style
- ✓ **Solution-oriented attitude, pragmatic. Good problem-solving skills**
 - Following and improving processes

If you are interested in this internship, please send your CV and the reason why you would like to apply for this internship to:

internship@Chipglobe.com